



THE DATASHEET OF TSSA3U60



3A, 60V Trench Schottky Surface Mount Rectifier

FEATURES

- Low power loss, high efficiency
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Trench Schottky barrier rectifier are designed for high frequency miniature switched mode power supplies such as adapters, lighting

MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	3	A
V_{RRM}	60	V
I_{FSM}	60	A
$T_{J\ MAX}$	150	°C
Package	DO-214AC (SMA)	
Configuration	Single die	



DO-214AC (SMA)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	TSSA3U60	UNIT
Marking code on the device		3U60	
Repetitive peak reverse voltage	V_{RRM}	60	V
Reverse voltage, total rms value	$V_{R(RMS)}$	42	V
Forward current	I_F	3	A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	60	A
Junction temperature	T_J	- 55 to +150	°C
Storage temperature	T_{STG}	- 55 to +150	°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	27	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	70	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	20	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 3\text{A}, T_J = 25^\circ\text{C}$	V_F	0.49	0.54	V
	$I_F = 3\text{A}, T_J = 125^\circ\text{C}$		0.43	0.50	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	500	μA
	$T_J = 125^\circ\text{C}$		-	30	mA
Junction capacitance	1MHz, $V_R = 4.0\text{V}$	C_J	241	-	pF
Reverse recovery time	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	t_{rr}	-	25	ns

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
TSSA3U60	DO-214AC (SMA)	7,500 / Tape & Reel

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

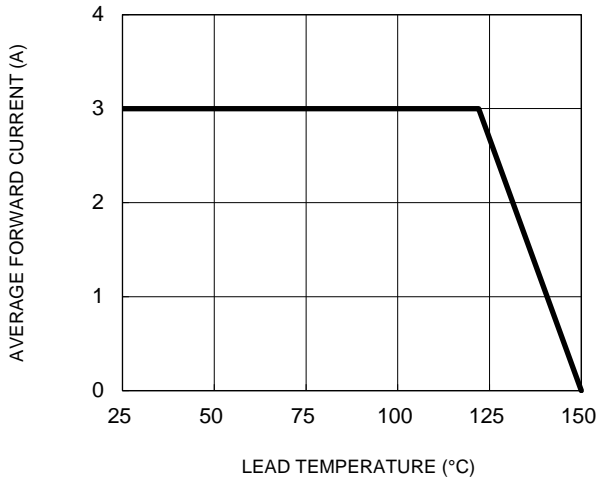


Fig.2 Typical Junction Capacitance

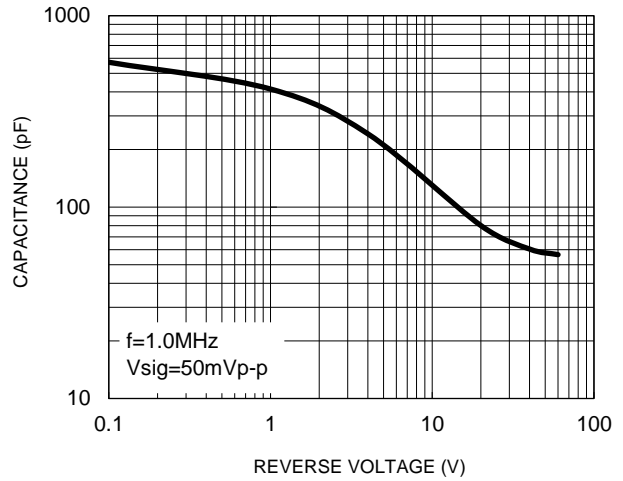


Fig.3 Typical Reverse Characteristics

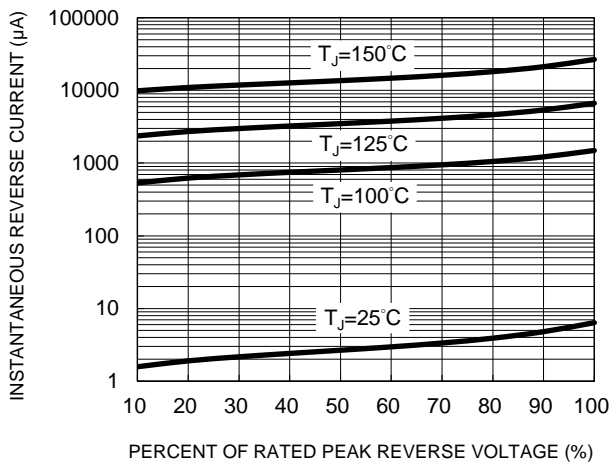


Fig.4 Typical Forward Characteristics

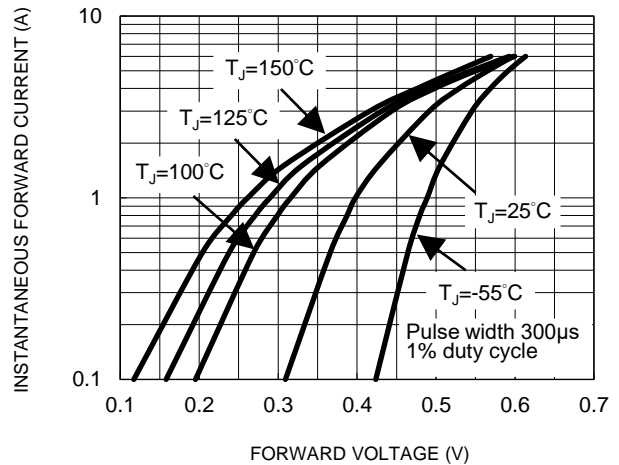
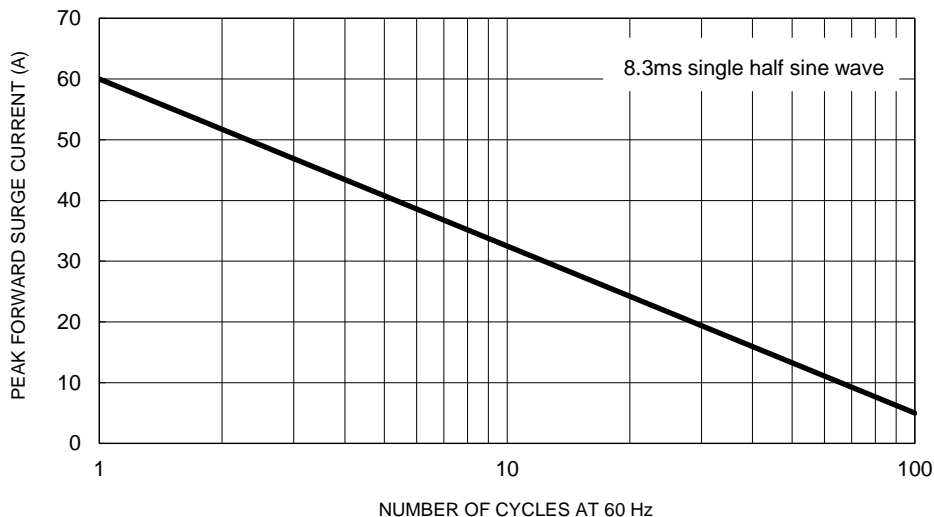
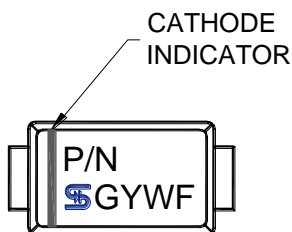
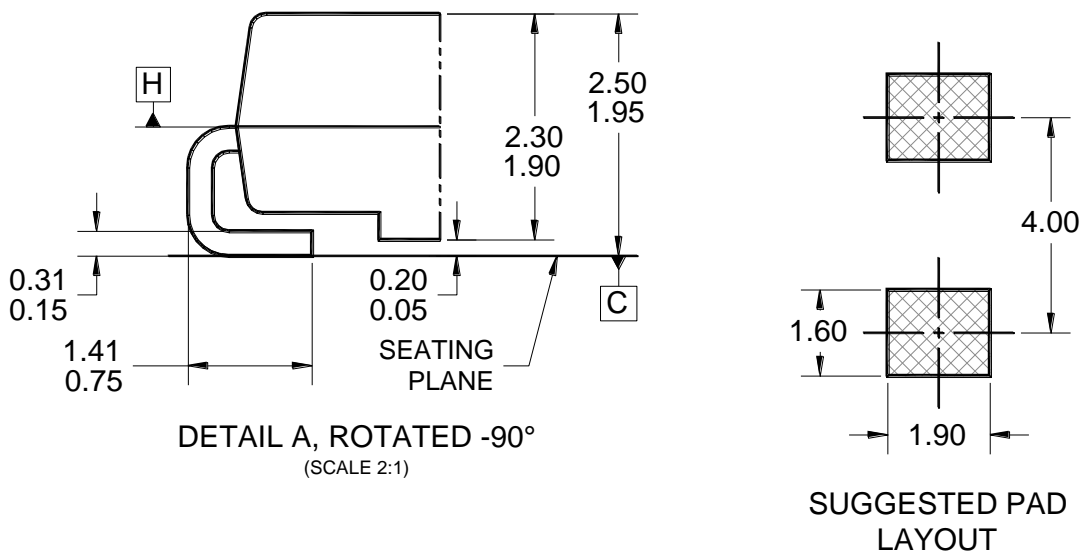
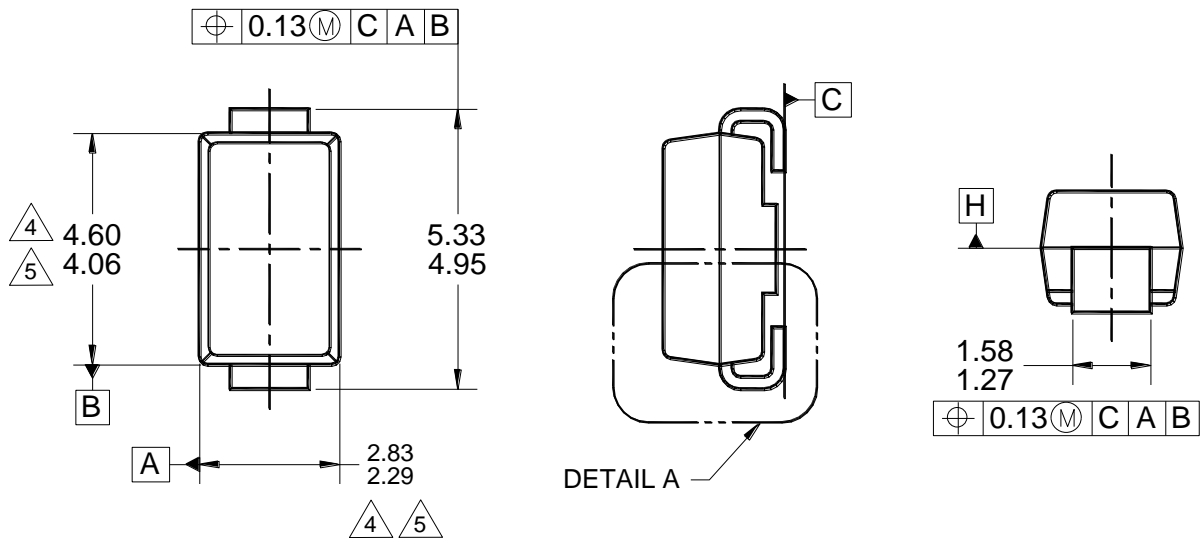


Fig.5 Maximum Non-Repetitive Forward Surge Current



PACKAGE OUTLINE DIMENSIONS

DO-214AC (SMA)



MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND
YW = DATE CODE
F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AC, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMC-034 REV A.

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